

24-3575-11 Information

Part Number 24-3575-11

Manufacturer Aries Electronics

Category Heisener.com

Connectors, Interconnects

Sockets for ICs, Transistors

Description

CONN IC DIP SOCKET ZIF 24POS TIN

Package

For the pricing/inventory/lead time, please contact

Website: https://www.heisener.com

E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

For Reference Only

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









24-3575-11 Specifications

Manufacturer Part Number	24-3575-11
Manufacturer	Aries Electronics
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	57
Туре	DIP, ZIF (ZIP), 0.3" (7.62mm) Row Spacing
Number of Positions or Pins (Grid)	24 (2 x 12)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Tin
Contact Finish Thickness - Mating	200μin (5.08μm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Closed Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Tin
Contact Finish Thickness - Post	200μin (5.08μm)
Contact Material - Post	Beryllium Copper
Housing Material	Polyphenylene Sulfide (PPS), Glass Filled
Operating Temperature	-
	Report errors?

24-3575-11 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

24-3575-11 Payment Methods



















24-3575-11 Shipping Methods













If you have any question about 24-3575-11, please do not hesitate to contact us!

Website: https://www.heisener.com E-mail: salesdept@heisener.com